



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

September 10, 2026

IGI Report Number

DESCRIPTION

SHAPE AND CUTTING STYLE

MEASUREMENTS

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

Cut Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

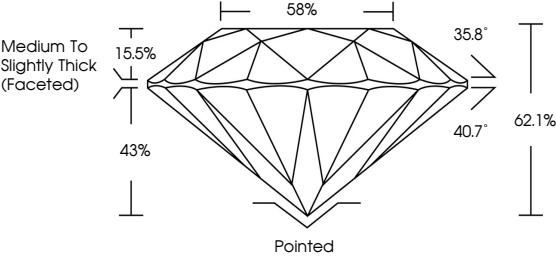
Inscription(s)

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

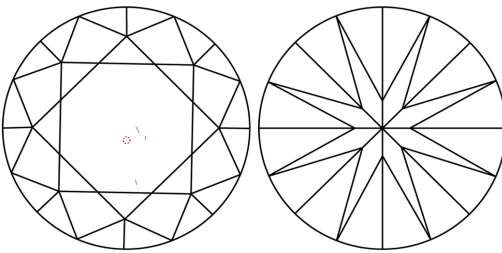
LG836604971

Report verification at [igi.org](#)

PROPORTIONS

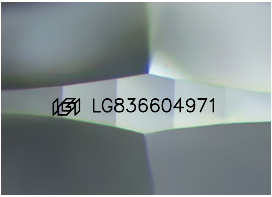


CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.



Sample Image Used

COLOR

FL

IF

VVS¹⁻²

VS¹⁻²

SI¹⁻²

I¹⁻³

CLARITY

FLawless

Internally FLawless

Very Very Slightly Included

Very Slightly Included

Slightly Included

Included

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ROUND BRILLIANT

6.45 - 6.53 X 4.02 MM

1.04 CARAT

D

VVS 2

IDEAL

88%

Medium To Slightly Thick (Faceted)

Pointed

EXCELLENT

EXCELLENT

NONE

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